



PRELIMINARY



NMC27C32B

## NMC27C32B 32,768-Bit (4k x 8) UV Erasable CMOS PROM

### General Description

The NMC27C32B is a high-speed 32k UV erasable and electrically reprogrammable CMOS EPROM, ideally suited for applications where fast turnaround, pattern experimentation and low power consumption are important requirements.

The NMC27C32B is designed to operate with a single +5V power supply with  $\pm 10\%$  tolerance. The CMOS design allows the part to operate over the Extended Temperature Range.

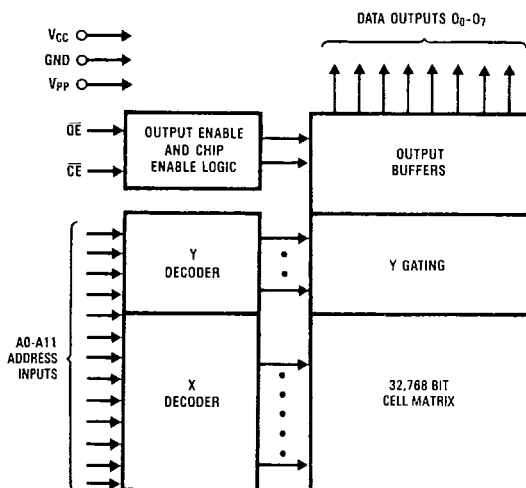
The NMC27C32B is packaged in a 24-pin dual-in-line package with transparent lid. The transparent lid allows the user to expose the chip to ultraviolet light to erase the bit pattern. A new pattern can then be written electrically into the device by following the programming procedure.

This EPROM is fabricated with National's proprietary, time proven microCMOS double-ploy silicon gate technology which combines high performance and high density with low power consumption and excellent reliability.

### Features

- Access time down to 200 ns, microCMOS technology
- Low CMOS power consumption
  - Active Power 27.5 mW max
  - Standby Power 0.55 mW max
- Performance compatible to NSC800™ CMOS micro-processor
- Single 5V power supply
- Extended temperature range (NMC27C32BQE),  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ , available
- Pin compatible with NMOS 32k EPROMS
- Fast and reliable programming
- Static operation—no clocks required
- TTL, CMOS compatible inputs/outputs
- TRI-STATE® output

### Block Diagram



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Pin Names

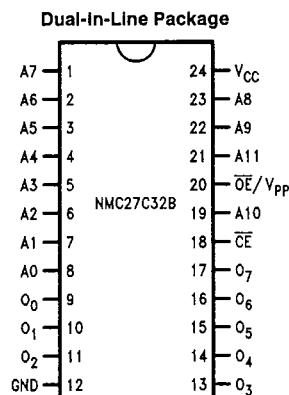
Pin Name	Function
A0-A11	Addresses
$\overline{\text{CE}}$	Chip Enable
$\overline{\text{OE}}$	Output Enable
O0-O7	Outputs
PGM	Program
NC	No Connect

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# Connection Diagram

27C56 27256	27C128 27128	27C64 2764	27C16 2716
V <sub>PP</sub>	V <sub>PP</sub>	V <sub>PP</sub>	
A12	A12	A12	A7
A7	A7	A7	A6
A6	A6	A6	A5
A5	A5	A5	A4
A4	A4	A4	A3
A3	A3	A3	A2
A2	A2	A2	A1
A1	A1	A1	A0
A0	A0	A0	O <sub>0</sub>
O <sub>0</sub>	O <sub>0</sub>	O <sub>0</sub>	O <sub>1</sub>
O <sub>1</sub>	O <sub>1</sub>	O <sub>1</sub>	O <sub>2</sub>
O <sub>2</sub>	O <sub>2</sub>	O <sub>2</sub>	GND
GND	GND	GND	GND



27C16 2716	27C64 2764	27C128 27128	27C256 27256
	V <sub>CC</sub>	V <sub>CC</sub>	V <sub>CC</sub>
	PGM	PGM	A14
V <sub>CC</sub>	NC	A13	A13
A8	A8	A8	A8
A9	A9	A9	A9
V <sub>PP</sub>	A11	A11	A11
OE	OE	OE	OE
A10	A10	A10	A10
CE	CE	CE	CE
O7	O7	O7	O7
O6	O6	O6	O6
O5	O5	O5	O5
O4	O4	O4	O4
O3	O3	O3	O3

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## Top View

Note: National's socket compatible EPROM pin configurations are shown in the blocks adjacent to the NMC27C32B pins.

See NS Package Number J24A-Q

## Commercial Temp Range (0°C to +70°C)

V<sub>CC</sub> = 5V ± 10%

Parameter/Order Number	Access Time (ns)
NMC27C32BQ200	200
NMC27C32BQ350	350

## Extended Temp Range (-40°C to +85°C)

V<sub>CC</sub> = 5V ± 10%

Parameter/Order Number	Access Time (ns)
NMC27C32BQE200	200
NMC27C32BQE350	350

**Absolute Maximum Ratings** (Note 1)

Specifications for Military/Aerospace products are not contained in this datasheet. Refer to the associated reliability electrical test specifications document.

Temperature Under Bias  $-10^{\circ}\text{C}$  to  $+80^{\circ}\text{C}$

Storage Temperature  $-65^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$

All Input Voltages with Respect to Ground  $+6.5\text{V}$  to  $-0.3\text{V}$

All Output Voltages with Respect to Ground  $V_{\text{CC}} + 0.3\text{V}$  to  $\text{GND} - 0.3\text{V}$

$V_{\text{pp}}$  Supply and A9 Voltage with Respect to Ground  $+14.0\text{V}$  to  $-0.3\text{V}$

Power Dissipation  $1.0\text{W}$

Lead Temp. (Soldering, 10 sec.)  $300^{\circ}\text{C}$

ESD rating to be determined.

**Operating Conditions** (Note 7)

Temperature Range  
NMC27C32BQ200, 350  $0^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$   
NMC27C32BQE200, E350  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

$V_{\text{CC}}$  Power Supply  $+5\text{V} \pm 10\%$

**READ OPERATION****DC Electrical Characteristics**

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
$I_{\text{LI}}$	Input Load Current	$V_{\text{IN}} = V_{\text{CC}}$ or GND			10	$\mu\text{A}$
$I_{\text{LO}}$	Output Leakage Current	$V_{\text{OUT}} = V_{\text{CC}}$ or GND, $\overline{\text{OE}} = V_{\text{IH}}$			10	$\mu\text{A}$
$I_{\text{CC1}}$	$V_{\text{CC}}$ Current (Active) TTL Inputs	$\overline{\text{OE}} = V_{\text{IL}}$ , $f = 1\text{ MHz}$ Inputs = $V_{\text{IH}}$ or $V_{\text{IL}}$ $I/\text{O} = 0\text{ mA}$		2	10	$\text{mA}$
$I_{\text{CC2}}$	$V_{\text{CC}}$ Current (Active) CMOS Inputs	$\overline{\text{OE}} = \text{GND}$ , $f = 1\text{ MHz}$ Inputs = $V_{\text{CC}}$ or GND, $I/\text{O} = 0\text{ mA}$		1	5	$\text{mA}$
$I_{\text{CCSB1}}$	$V_{\text{CC}}$ Current (Standby) TTL Inputs	$\overline{\text{OE}} = V_{\text{IH}}$		0.1	1	$\text{mA}$
$I_{\text{CCSB2}}$	$V_{\text{CC}}$ Current (Standby) CMOS Inputs	$\overline{\text{OE}} = V_{\text{CC}}$		0.01	100	$\mu\text{A}$
$V_{\text{IL}}$	Input Low Voltage		-0.1		0.8	V
$V_{\text{IH}}$	Input High Voltage		2.0		$V_{\text{CC}} + 1$	V
$V_{\text{OL1}}$	Output Low Voltage	$I_{\text{OL}} = 2.1\text{ mA}$			0.45	V
$V_{\text{OH1}}$	Output High Voltage	$I_{\text{OH}} = -400\text{ }\mu\text{A}$	2.4			V
$V_{\text{OL2}}$	Output Low Voltage	$I_{\text{OL}} = 0\text{ }\mu\text{A}$			0.1	V
$V_{\text{OH2}}$	Output High Voltage	$I_{\text{OH}} = 0\text{ }\mu\text{A}$	$V_{\text{CC}} - 0.1$			V

**AC Electrical Characteristics**

Symbol	Parameter	Conditions	NMC27C32B 200, E200		NMC27C32B 350, E350		Units
			Min	Max	Min	Max	
$t_{\text{ACC}}$	Address to Output Delay	$\overline{\text{OE}} = \overline{\text{OE}} = V_{\text{IL}}$		200		350	ns
$t_{\text{CE}}$	$\overline{\text{OE}}$ to Output Delay	$\overline{\text{OE}} = V_{\text{IL}}$		200		350	ns
$t_{\text{OE}}$	$\overline{\text{OE}}$ to Output Delay	$\overline{\text{OE}} = V_{\text{IL}}$		60		150	ns
$t_{\text{DF}}$	$\overline{\text{OE}}$ High to Output Float	$\overline{\text{OE}} = V_{\text{IL}}$	0	60	0	130	ns
$t_{\text{OH}}$	Output Hold from Addresses, $\overline{\text{CE}}$ or $\overline{\text{OE}}$ , Whichever Occurred First	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}$	0		0		ns

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# Capacitance $T_A = +25^\circ\text{C}$ , $f = 1\text{ MHz}$ (Note 3)

Symbol	Parameter	Conditions	Typ	Max	Units
$C_{IN}$	Input Capacitance	$V_{IN} = 0\text{V}$	4	6	pF
$C_{OUT}$	Output Capacitance	$V_{OUT} = 0\text{V}$	8	12	pF

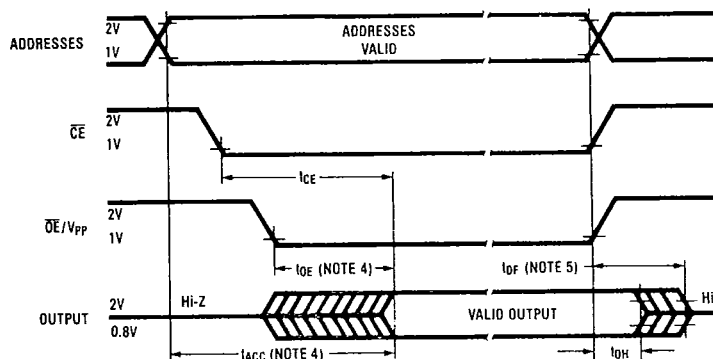
## AC Test Conditions

Output Load 1 TTL Gate and  $C_L = 100\text{ pF}$  (Note 9)  
 Input Rise and Fall Times  $\leq 20\text{ ns}$   
 Input Pulse Levels 0.45V to 2.4V

Timing Measurement Reference Level  
 Inputs  
 Outputs

1V and 2V  
 0.8V and 2V

## AC Waveforms



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**Note 1:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Note 2:** Typical values are for  $T_A = +25^\circ\text{C}$  and nominal supply voltages.

**Note 3:** This parameter is only sampled and is not 100% tested.

**Note 4:** OE may be delayed up to  $t_{ACC} - t_{OE}$  after the falling edge of CE without impacting  $t_{ACC}$ .

**Note 5:** The  $t_{OF}$  compare level is determined as follows:

High to TRI-STATE, the measured  $V_{OH1}$  (DC)  $-0.10\text{V}$

Low to TRI-STATE, the measured  $V_{OL1}$  (DC)  $+0.10\text{V}$

**Note 6:** TRI-STATE may be attained using OE or CE.

**Note 7:** The power switching characteristics of EPROMs require careful device decoupling. It is recommended that at least a  $0.1\text{ }\mu\text{F}$  ceramic capacitor be used on every device between  $V_{CC}$  and GND.

**Note 8:** The outputs must be restricted to  $V_{CC} + 0.3\text{V}$  to avoid latch-up and device damage.

**Note 9:** 1 TTL Gate:  $I_{OL} = 1.6\text{ mA}$ ,  $I_{OH} = -400\text{ }\mu\text{A}$ .

$C_L$ : 100 pF includes fixture capacitance.

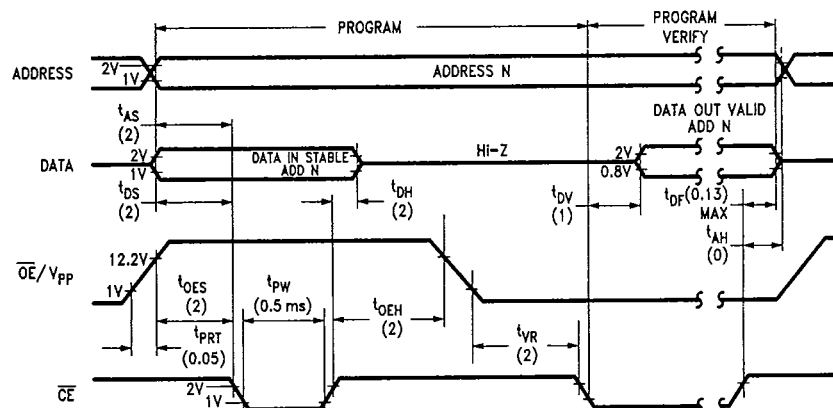
# Programming Characteristics $T_A = +25^\circ\text{C} \pm 5^\circ\text{C}$ , $V_{CC} = 6\text{V} \pm 0.25\text{V}$ , $V_{PP} = 12.2 - 13.3\text{V}$ (Notes 2, 3, & 4)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$t_{AS}$	Address Set-Up Time		2			$\mu\text{s}$
$t_{OES}$	$\overline{OE}$ Set-Up Time		2			$\mu\text{s}$
$t_{DS}$	Data Set-Up Time		2			$\mu\text{s}$
$t_{AH}$	Address Hold Time		0			$\mu\text{s}$
$t_{DH}$	Data Hold Time		2			$\mu\text{s}$
$t_{VR}$	$V_{PP}$ Recovery Time		2			$\mu\text{s}$
$t_{OEH}$	$\overline{OE}$ Hold Time		2			$\mu\text{s}$
$t_{DV}$	Data Valid From $\overline{OE}$	$\overline{OE} = \overline{OE} = V_{IL}$			1	$\mu\text{s}$
$t_{PRT}$	$\overline{OE}$ Pulse Rise Time During Programming		50			ns
$t_{DF}$	Output Enable to Output Float Delay	$\overline{OE} = V_{IL}$	0		130	ns
$t_{PW}$	Program Pulse Width		0.5	0.5	10	ms
$I_{PP}$	$V_{PP}$ Supply Current During Programming Pulse	$\overline{OE} = V_{IL}$			30	mA
$I_{CC}$	$V_{CC}$ Supply Current				10	mA

## AC Test Conditions

$V_{CC}$	$6\text{V} \pm 0.25\text{V}$	Timing Measurement Reference Level	
$V_{PP}$	$12.2 - 13.3\text{V}$	Inputs	1V and 2V
Input Rise and Fall Times	$\leq 20\text{ ns}$	Outputs	0.8V and 2V
Input Pulse Levels	$0.45\text{V to } 2.4\text{V}$		

## Programming Waveforms (Note 3)



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Note: All times shown in parentheses are minimum and in  $\mu\text{s}$  unless otherwise specified.

Note 1: National's standard product warranty applies only to devices programmed to specifications described herein.

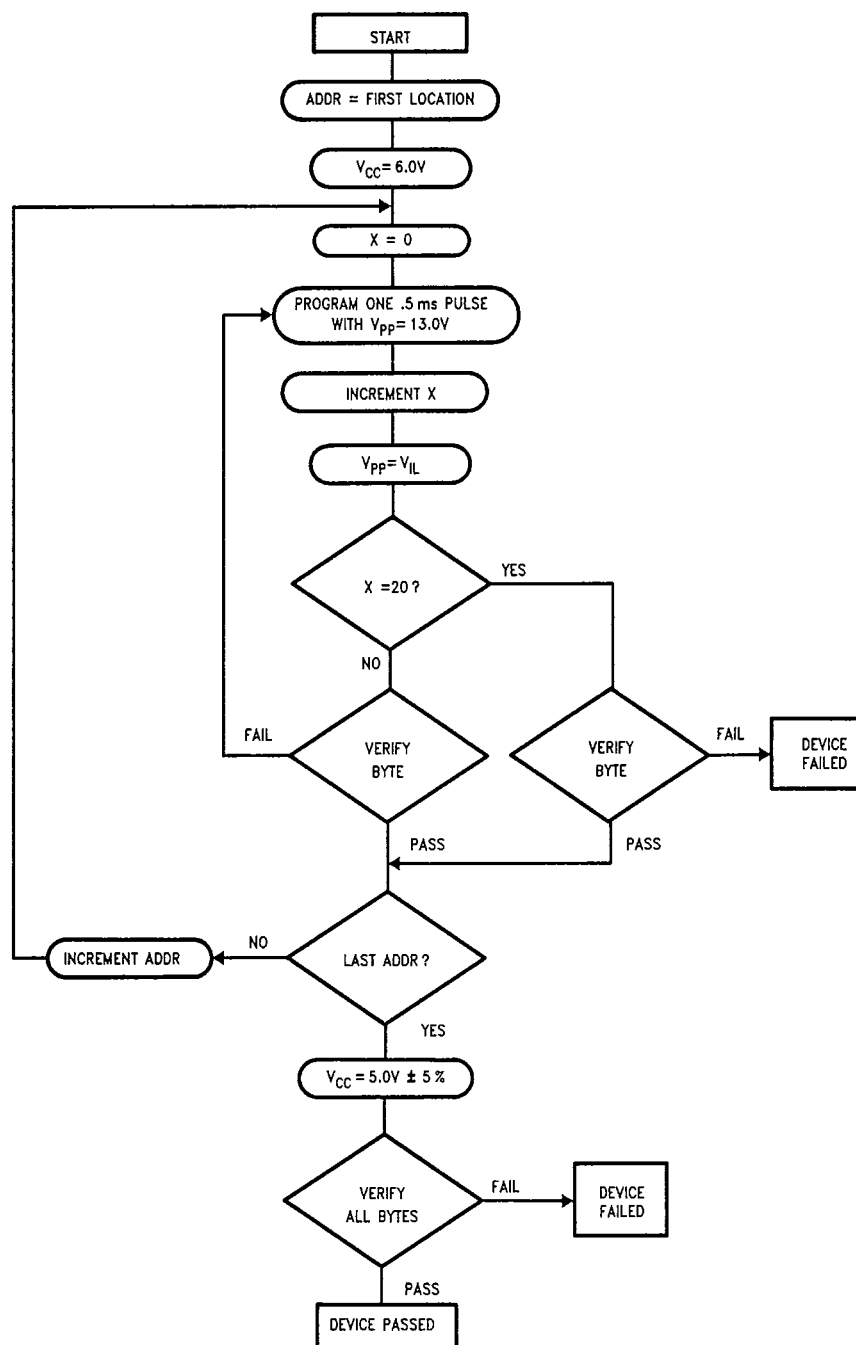
Note 2:  $V_{CC}$  must be applied simultaneously or before  $V_{PP}$  and removed simultaneously or after  $V_{PP}$ . The NMC27C32B must not be inserted into or removed from a board with voltage applied to  $V_{PP}$  or  $V_{CC}$ .

Note 3: The maximum allowable voltage which may be applied to the  $V_{PP}$  pin during programming is 14V. Care must be taken when switching the  $V_{PP}$  supply to prevent overshoot exceeding this 14V maximum specification. At least a  $0.1\text{ }\mu\text{F}$  capacitor is required across  $V_{PP}$ ,  $V_{CC}$  to GND to suppress spurious voltage transients which may damage the device.

Note 4: Programming and program verify are tested at nominal power supply voltages.

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## Interactive Programming Flow Chart



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## Functional Description

### DEVICE OPERATION

The five modes of operation of the NMC27C32B are listed in Table 1. A single 5V power supply is required in the read mode. All inputs are TTL levels except for  $\overline{OE}/V_{PP}$  during programming. In the program mode the  $\overline{OE}/V_{PP}$  input is pulsed from a TTL low level to 13V.

#### Read Mode

The NMC27C32B has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable ( $\overline{CE}$ ) is the power control and should be used for device selection. Output Enable ( $\overline{OE}$ ) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time ( $t_{ACC}$ ) is equal to the delay from  $\overline{CE}$  to output ( $t_{CE}$ ). Data is available at the outputs after the falling edge of  $\overline{OE}$ , assuming that  $\overline{CE}$  has been low and addresses have been stable for at least  $t_{ACC}-t_{OE}$ .

#### Standby Mode

The NMC27C32B has a standby mode which reduces the active power dissipation by 99%, from 26.3 mW to 0.53 mW. The NMC27C32B is placed in the standby mode by applying a CMOS high signal to the  $\overline{CE}$  input. When in standby mode, the outputs are in a high impedance state, independent of the  $\overline{OE}$  input.

#### Output OR-Tying

Because EPROMs are usually used in larger memory arrays, National has provided a 2-line control function that accommodates this use of multiple memory connection. The 2-line control function allows for:

- The lowest possible memory power dissipation, and
- complete assurance that output bus contention will not occur.

To most efficiently use these two control lines, it is recommended that  $\overline{CE}$  (pin 18) be decoded and used as the primary device selecting function, while  $\overline{OE}$  (pin 20) be made a common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low

power standby modes and that the output pins are active only when data is desired from a particular memory device.

### Programming

CAUTION: Exceeding 14V or pin 1 ( $V_{PP}$ ) will damage the NMC27C32B.

Initially, and after each erasure, all bits of the NMC27C32B are in the "1" state. Data is introduced by selectively programming "0s" into the desired bit locations. Although only "0s" will be programmed, both "1s" and "0s" can be presented in the data word. The only way to change a "0" to a "1" is by ultraviolet light erasure.

The NMC27C32B is in the programming mode when  $\overline{OE}/V_{PP}$  is at 13V. It is required that at least a 0.1  $\mu F$  capacitor be placed across  $\overline{OE}/V_{PP}$ ,  $V_{CC}$  and ground to suppress spurious voltage transients which may damage the device. The data to be programmed is applied 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL.

When the address and data are stable, an active low, TTL program pulse is applied to the  $\overline{CE}$  input. A program pulse must be applied at each address location to be programmed. Any location may be programmed at any time—either individually, sequentially, or at random. The NMC27C32B is designed to be programmed in either of two ways: single pulse programming, where each address is programmed with a 10 ms pulse; or interactive programming, where each address is programmed with a series of 0.5 ms pulses until it verifies (up to a maximum of 20 pulses or 10 ms). Only the interactive programming method has been tested. The NMC27C32B must not be programmed with a DC signal applied to the  $\overline{CE}$  input.

Programming multiple NMC27C32Bs in parallel with the same data can be easily accomplished due to the simplicity of the programming requirements. Like inputs of the paralleled NMC27C32B may be connected together when they are programmed with the same data. A low level TTL pulse applied to the  $\overline{CE}$  input programs the paralleled NMC27C32B.

TABLE 1. Mode Selection

Pins	$\overline{CE}$ (18)	$\overline{OE}/V_{PP}$ (20)	$V_{CC}$ (24)	Outputs (9-11, 13-17)
Mode				
Read	$V_{IL}$	$V_{IL}$	5	$D_{OUT}$
Standby	$V_{IH}$	Don't Care	5	Hi-Z
Program	$V_{IL}$	13	6	$D_{IN}$
Program Verify	$V_{IL}$	$V_{IL}$	6	$D_{OUT}$
Program Inhibit	$V_{IH}$	13	6	Hi-Z

## Functional Description (Continued)

### Program Inhibit

Programming multiple NMC27C32B in parallel with different data is also easily accomplished. Except for  $\overline{CE}$  all like inputs (including  $\overline{OE}$ ) of the parallel NMC27C32B may be common. A TTL low level program pulse applied to an NMC27C32B's  $\overline{CE}$  input with  $\overline{OE}/V_{PP}$  at 13.0V will program that NMC27C32B. A TTL high level  $\overline{CE}$  input inhibits the other NMC27C32B from being programmed.

### Program Verify

A verify should be performed on the programmed bits to determine whether they were correctly programmed. The verify is accomplished with  $\overline{OE}/V_{PP}$  and  $\overline{CE}$  at  $V_{IL}$ . Data should be verified  $t_{DV}$  after the falling edge of  $\overline{CE}$ .

### MANUFACTURER'S IDENTIFICATION CODE

The NMC27C32B has a manufacturer's identification code to aid in programming. The code, shown in Table II, is two bytes wide and is stored in a ROM configuration on the chip. It identifies the manufacturer and the device type. The code for the NMC27C32B is, "8F61", where "8F" designates that it is made by National Semiconductor, and "61" designates a 32k part.

The code is accessed by applying 12V  $\pm 0.5V$  to address pin A9. Addresses A1-A8, A10-A11,  $\overline{CE}$ , and  $\overline{OE}$  are held at  $V_{IL}$ . Address A0 is held at  $V_{IL}$  for the manufacturer's code, and at  $V_{IH}$  for the device code. The code is read out on the 8 data pins. Proper code access is only guaranteed at 25°C  $\pm 5^\circ\text{C}$ .

The primary purpose of the manufacturer's identification code is automatic programming control. When the device is inserted in an EPROM programmer socket, the programmer reads the code and then automatically calls up the specific programming algorithm for the part. This automatic programming control is only possible with programmers which have the capability of reading the code.

### ERASURE CHARACTERISTICS

The erasure characteristics of the NMC27C32B are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms ( $\text{\AA}$ ). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the 3000 $\text{\AA}$ -4000 $\text{\AA}$  range. Data shows that constant exposure to room-level fluorescent lighting could erase the typical NMC27C32B in approximately 3 years, while it would take approximately 1 week to cause erasure when exposed to direct sunlight. If

the NMC27C32B is to be exposed to these types of lighting conditions for extended periods of time, opaque labels should be placed over the NMC27C32B's window to prevent unintentional erasure. Covering the window will also prevent temporary functional failure due to the generation of photo currents.

The recommended erasure procedure for the NMC27C32B is exposure to short wave ultraviolet light which has a wavelength of 2537 Angstroms ( $\text{\AA}$ ). The integrated dose (i.e., UV intensity  $\times$  exposure time) for erasure should be a minimum of 15W-sec/cm<sup>2</sup>.

The NMC27C32B should be placed within 1 inch of the lamp tubes during erasure. Some lamps have a filter on their tubes which should be removed before erasure. Table III shows the minimum NMC27C32B erasure time for various light intensities.

An erasure system should be calibrated periodically. The distance from lamp to unit should be maintained at one inch. The erasure time increases as the square of the distance. (If distance is doubled the erasure time increases by a factor of 4.) Lamps lose intensity as they age. When a lamp is changed, the distance has changed or the lamp has aged, the system should be checked to make certain full erasure is occurring. Incomplete erasure will cause symptoms that can be misleading. Programmers, components, and even system designs have been erroneously suspected when incomplete erasure was the problem.

### SYSTEM CONSIDERATION

The power switching characteristics of EPROMs require careful decoupling of the devices. The supply current,  $I_{CC}$ , has three segments that are of interest to the system designer—the standby current level, the active current level, and the transient current peaks that are produced by voltage transitions on input pins. The magnitude of these transient current peaks is dependent on the output capacitance loading of the device. The associated  $V_{CC}$  transient voltage peaks can be suppressed by properly selected decoupling capacitors. It is recommended that at least a 0.1  $\mu\text{F}$  ceramic capacitor be used on every device between  $V_{CC}$  and GND. This should be a high frequency capacitor of low inherent inductance. In addition, at least a 4.7  $\mu\text{F}$  bulk electrolytic capacitor should be used between  $V_{CC}$  and GND for each eight devices. The bulk capacitor should be located near where the power supply is connected to the array. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of the PC board traces.

TABLE II. Manufacturer's Identification Code

Pins	A <sub>0</sub> (8)	0 <sub>7</sub> (17)	0 <sub>6</sub> (16)	0 <sub>5</sub> (15)	0 <sub>4</sub> (14)	0 <sub>3</sub> (13)	0 <sub>2</sub> (11)	0 <sub>1</sub> (10)	0 <sub>0</sub> (9)	Hex Data
Manufacturer Code	$V_{IL}$	1	0	0	0	1	1	1	1	8F
Device Code	$V_{IH}$	0	1	1	0	0	0	0	1	61

TABLE III. Minimum NMC27C32B Erasure Time

Light Intensity (Micro-Watts/cm <sup>2</sup> )	Erasure Time (Minutes)
15,000	20
10,000	25
5,000	50